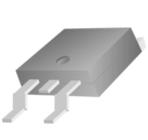
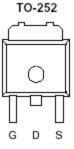
N-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low r_{DS(on)} provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe DPAK saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY				
V _{DS} (V)	$r_{\mathrm{DS(on)}} m(\Omega) \qquad I_{\mathrm{D}}$			
30	$59 @ V_{GS} = 10V$	24		
	$88 @ V_{GS} = 4.5V$	20		





Top View

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C UNLESS OTHERWISE NOTED)					
Parameter			Limit	Units	
Drain-Source Voltage		VDS	30	V	
Gate-Source Voltage		V ₆₈	±20	v	
Continuous Drain Current ^a	$T_{\rm C}=25^{\circ}{\rm C}$	I _D	24	•	
Pulsed Drain Current ^b		I _{DM}	75	A	
Continuous Source Current (Diode Conduction) ^a		Is	30	Α	
Power Dissipation ^a	$T_{\rm C}=25^{\circ}{\rm C}$	P _D	50	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Maximum	Units	
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	50	°C/W	
Maximum Junction-to-Case	$R_{\theta JC}$	3.0	°C/W	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. Pulse width limited by maximum junction temperature

SPECIFICATIONS ($T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)							
Deveneeder	Samula		Limits			TI	
Parameter	Symbol	Symbol Test Conditions		Тур	Max	Unit	
Static							
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$	1		2.3	V	
Gate-Body Leakage	Igss	$V_{DS} = 0 V, V_{GS} = 20 V$			±100	nA	
Zero Gate Voltage Drain Current	Idss	$V_{DS} = 24 V, V_{GS} = 0 V$			1		
Zero Gate voltage Dialit Current	IDSS	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			25	uA	
On-State Drain Current ^A	ID(on)	$V_{DS} = 5 V, V_{GS} = 10 V$	34			А	
Dig O Die A		$V_{GS} = 10 V, I_D = 12 A$ $V_{GS} = 4.5 V, I_D = 10 A$			59	mΩ	
Drain-Source On-Resistance ^A	fDS(on)				88		
Forward Tranconductance ^A	g _{fs}	$V_{DS} = 15 V$, $I_D = 12 A$		22		S	
Diode Forward Voltage	Vsd	$I_{S} = 24 \text{ A}, V_{GS} = 0 \text{ V}$		1.1		V	
Dynamic ^b							
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_D = 10 \text{ A}$		2.2			
Gate-Source Charge	Qgs			0.5		nC	
Gate-Drain Charge	Qgd			0.8			
Input Capacitance	Ciss	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1MHz		720		pF	
Output Capacitance	Coss			165			
Reverse Transfer Capacitance	Crss			60			
Turn-On Delay Time	td(on)	$V_{DD} = 25 V, R_L = 25 \Omega, ID = 24 A,$ $V_{GEN} = 10 V$		16			
Rise Time	tr			5		nS	
Turn-Off Delay Time	t _{d(off)}			23			
Fall-Time	tf			3			

Notes

- a. Pulse test: $PW \le 300$ us duty cycle $\le 2\%$.
- b. Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics (N-Channel)

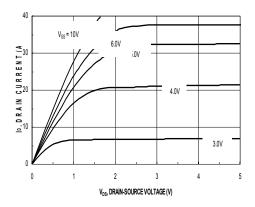


Figure 1. On-Region Characteristics

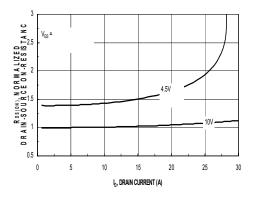


Figure 3. On Resistance Vs Vgs Voltage

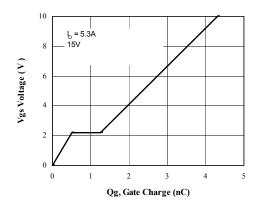


Figure 5. Gate Charge Characteristics

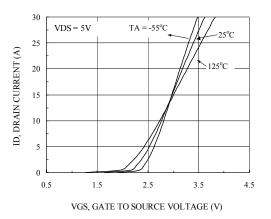


Figure 2. Body Diode Forward Voltage Variation

with Source Current and Temperature

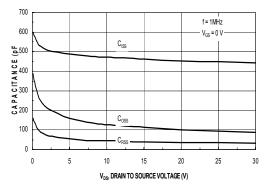


Figure 4. Capacitance Characteristics

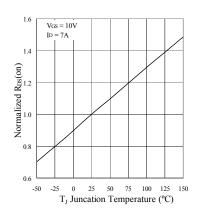


Figure 6. On-Resistance Variation with Temperature

Typical Electrical Characteristics (N-Channel)

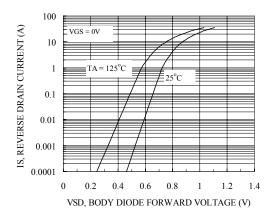


Figure 7. Transfer Characteristics

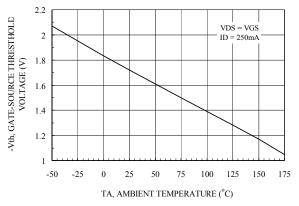


Figure 9. Vth Gate to Source Voltage Vs Temperature

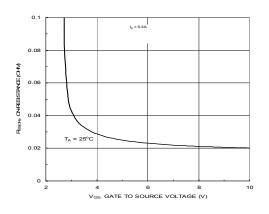


Figure 8. On-Resistance with Gate to Source Voltage

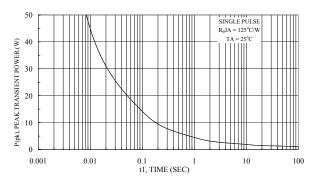
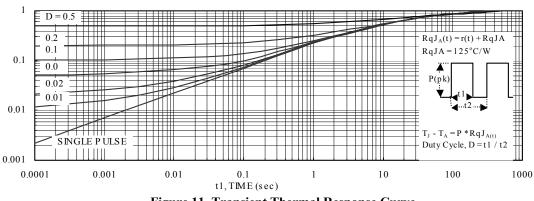


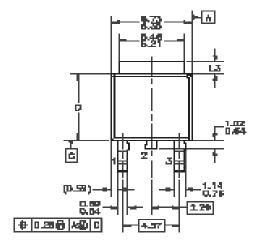
Figure 10. Single Pulse Maximum Power Dissipation

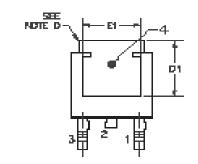


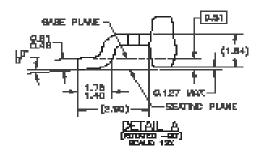


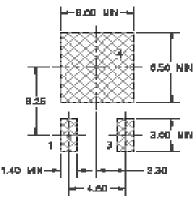


Package Information

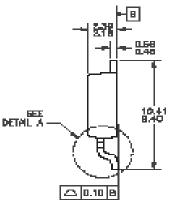








LAND PATTERN RECOMMENDATION



- NOTES: UNLESS OTHERWISE SPECIFIED
 - ALL DIVENERAS ARE IN NULLHETERS. 骨目

 - THIS PACIONCE CONFORME TO LEDEC, TO-262, IBBUE C, VARIATION AA IN AE, DATED NOW 1989. Dimensioning and toleranging per C)
 - AGNE 114.00-1984. HEAT SINK TOP EDGE COULD BE IN CHANFERED
 - D) CORVERS OR EDGE PROTRUSION. Ð

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